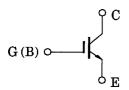
TOSHIBA IGBT Module Silicon N - Channel IGBT

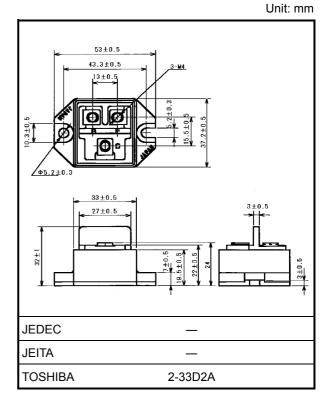
MG25Q1BS11

High Power Switching Applications Motor Control Applications

- Enhancement-mode
- The electrodes are isolated from case.

Equivalent Circuit





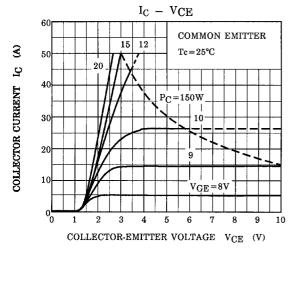
Maximum Ratings (Ta = 25°C)

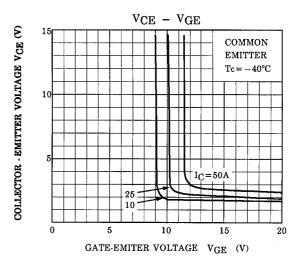
Characte	ristic	Symbol	Rating	Unit	
Collector-emitter voltage		V _{CES}	1200	V	
Gate-emitter voltage		V _{GES}	±20	V	
Collector current	DC	IC	25	Α	
	1ms	I _{CP}	50		
Collector power dissipation (Tc = 25°C)		PC	250	W	
Junction temperature		Tj	150	°C	
Storage temperature Range		T _{stg}	-40 to 125	°C	
Isolation voltage		V _{Isol}	2500 (AC 1 Minute)	V	
Screw torque (Terminal / mounting)		_	_ 2/3		

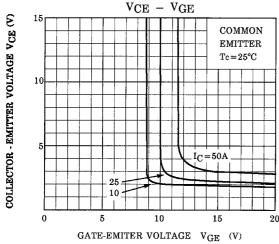
Electrical Characteristics (Ta = 25°C)

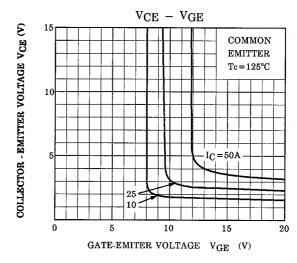
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GES}	V _{GE} = ±20V, V _{CE} = 0	_	_	±500	nA
Collector cut-off current		I _{CES}	V _{CE} = 1200V, V _{GE} = 0	_	_	1.0	mA
Gate-emitter cut-off voltage		V _{GE} (OFF)	I _C = 25mA, V _{CE} = 5V	3.0	_	6.0	V
Collector-emitter Saturation voltage		V _{CE (sat)}	I _C = 25A, V _{GE} = 15V	_	2.2	2.7	V
Input capacitance		C _{ies}	V _{CE} = 10V, V _{GE} = 0, f=1MHz	_	3000	_	pF
Switching time	Rise time	t _r	15V 51Ω 54 8	_	0.3	0.6	- - µs
	Turn-on time	t _{on}		_	0.4	0.8	
	Fall time	t _f		_	0.6	1.0	
	Turn-off time	t _{off}	600V	_	1.2	1.8	
Thermal resistance		R _{th (j-c)}	_	_	_	0.5	°C/W

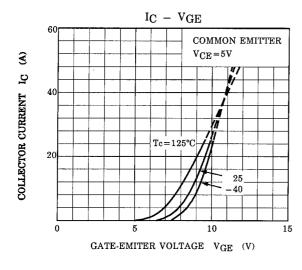
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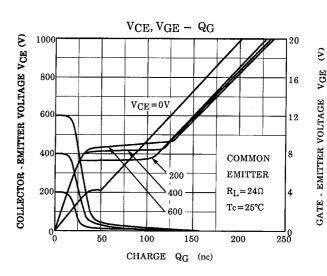




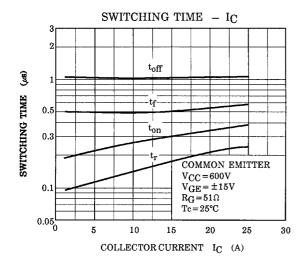


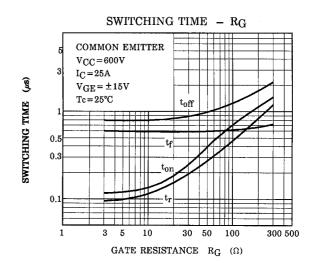


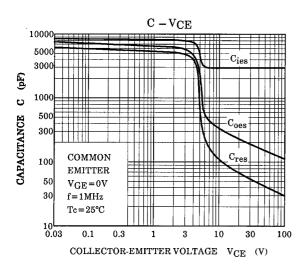


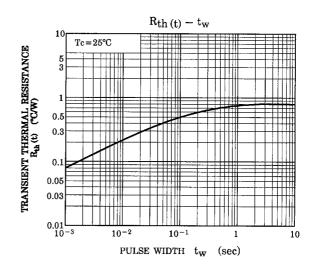


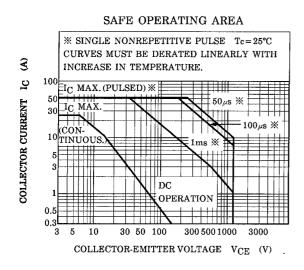
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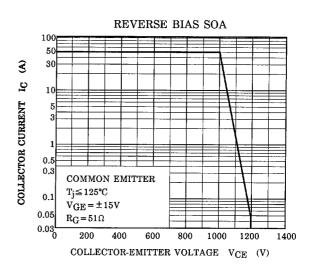












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